5N50K-TC

Preliminary

Power MOSFET

TO-220

TO-220F1

TO-252

TO-251

TO-220F

TO-220F2

5.0A, 500V N-CHANNEL POWER MOSFET

DESCRIPTION

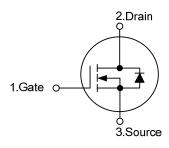
The UTC **5N50K-TC** is an N-channel power MOSFET adopting UTC's advanced technology to provide customers with DMOS, planar stripe technology. This technology is designed to meet the requirements of the minimum on-state resistance and perfect switching performance. It also can withstand high energy pulse in the avalanche and communication mode.

The UTC **5N50K-TC** can be used in applications, such as active power factor correction, high efficiency switched mode power supplies, electronic lamp ballasts based on half bridge topology.

■ FEATURES

- * $R_{DS(ON)}$ < 1.65 Ω @ V_{GS} =10V, I_D =2.5A
- * 100% avalanche tested
- * High switching speed

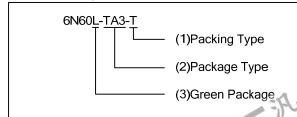
■ SYMBOL



ORDERING INFORMATION

Ordering Number		Dealtage	Pin Assignment			Deaking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
5N50KL-TA3-T	5N50KG-TA3-T	5N50KG-TA3-T TO-220 G D		D	S	Tube	
5N50KL-TF1-T	5N50KG-TF1-T	5N50KG-TF1-T TO-220F1 G D		D	S	Tube	
5N50KL-TF3-T	5N50KG-TF3-T	TO-220F2	G	D	S	Tube	
5N50KL-TF3-T	5N50KG-TF3-T	TO-220F	G	D	S	Tube	
5N50KL-TM3-T	5N50KG-TM3-T	TO-251	G	D	S	Tube	
5N50KL-TN3-R	5N50KG-TN3-R	TO-252	G	D	S	Tape Reel	

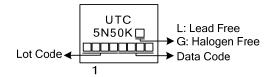
Note: Pin Assignment: G: Gate D: Drain S: Source



- (1) T: Tube, R: Tape Reel
- (2) TA3: TO-220, TF3: TO-220F, TF1: TO-220F1,
 - TF2: TO-220F2, TM3: TO-251, TN3: TO-252
- (3) L: Lead Free, G: Halogen Free and Lead Free

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MARKING





■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	500	V
Gate-Source Voltage		V _{GSS} ±30		V
Drain Current	Continuous	Ι _D	5	Α
	Pulsed (Note 2)	I_{DM}	20	Α
Avalanche Current (Note 2)		I_{AR}	I _{AR} 4.3	
Avalanche Energy	Single Pulsed (Note 3)	E _{AS} 92		mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	1.7	V/ns
Power Dissipation	TO-220		78	W
	TO-220F/TO-220F1	Б	36	W
	TO-220F2	P_D	29	W
	TO-251/TO-252		54	W
Junction Temperature		TJ	+150	°C
Storage Temperature		T_{STG}	-55 ~ + 150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature
- 3. L = 10mH, I_{AS} = 4.3A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25 $^{\circ}$ C
- 4. $I_{SD} \le 5.0 A$, di/dt $\le 200 A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25 ^{\circ}C$

■ THERMAL DATA

PARAMETER	PACKAGE	SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220/TO-220F TO-220F1/TO-220F2	θ_{JA}	62.5	°C/W
	TO-251/TO-252		110	°C/W
Junction to Case	TO-220		1.16	°C/W
	TO-220F/TO-220F1	0	4.2	°C/W
	TO-220F2	θ _{JC}	4.18	°C/W
	TO-251/TO-252		2.3	°C/W



■ ELECTRICAL CHARACTERISTICS (T_J =25°C, unless otherwise specified)

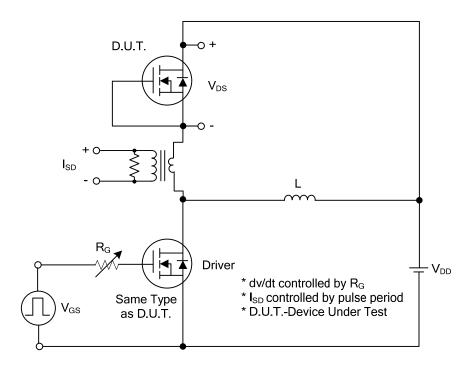
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	$I_D = 250 \mu A, V_{GS} = 0 V$	500			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =500V, V _{GS} =0V			1	μΑ
Gate- Source Leakage Current	Forward	_	V _{GS} =30V, V _{DS} =0V			100	nA
	Reverse	I _{GSS}	V_{GS} =-30V, V_{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_D=250\mu A$	2.0		4.0	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V_{GS} =10V, I_{D} =2.5A			1.65	Ω
DYNAMIC PARAMETERS							
Input Capacitance		C_{ISS})/)/ 0)/)/ 0F)/		565		pF
Output Capacitance		Coss	V V _{GS} =0V,V _{DS} =25V, -f=1.0MHz		68		pF
Reverse Transfer Capacitance		C_{RSS}	I = 1.0IVII IZ		5.5		pF
SWITCHING PARAMETERS	_				-	-	_
Total Gate Charge (Note 1)		Q_G	V _{DS} =50V, V _{GS} =10V, I _D =1.3A		39		nC
Gate to Source Charge		Q_GS	I_{G} =100µA (Note 1, 2)		3.2		nC
Gate to Drain Charge		Q_GD	IG-100μΑ (Note 1, 2)		3.6		nC
Turn-ON Delay Time (Note 1)		$t_{D(ON)}$			35		ns
Rise Time		t_R	V_{DD} =30V, V_{GS} =10V, I_{D} =0.5A,		26		ns
Turn-OFF Delay Time		$t_{D(OFF)}$	$R_G = 25\Omega$ (Note 1, 2)		110		ns
Fall-Time		t_{F}			31		ns
SOURCE- DRAIN DIODE RATIN	NGS AND CH	ARACTERISTI	CS		-	-	-
Maximum Body-Diode Continuous Current		I_S				5	Α
Maximum Body-Diode Pulsed Current		I _{SM}				20	Α
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I _S =5.0A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Time (Note 1)		t _{rr}	I _S =5.0A, V _{GS} =0V,		280		ns
Body Diode Reverse Recovery Charge		Q_{rr}	dI _F /dt=100A/μs		1.2		μC

Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%

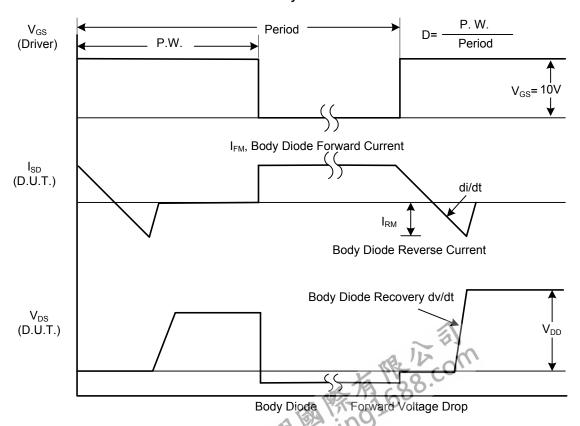


^{2.} Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

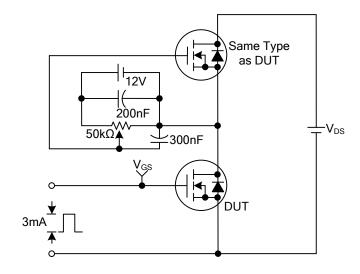


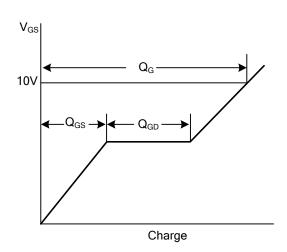
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dwdf Waveforms

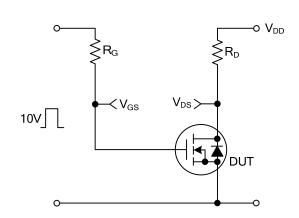
TEST CIRCUITS AND WAVEFORMS



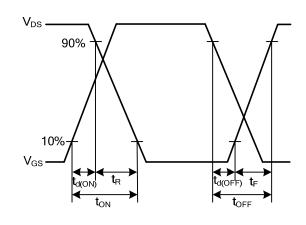


Gate Charge Test Circuit

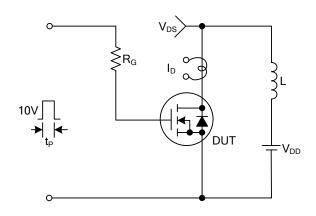
Gate Charge Waveforms



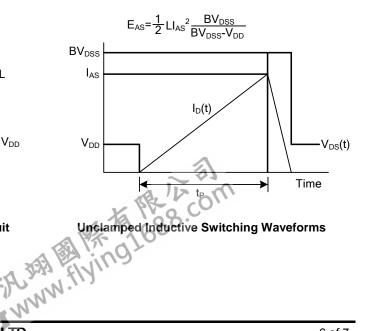
Resistive Switching Test Circuit



Resistive Switching Waveforms



Unclamped Inductive Switching Test Circuit



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